100 mA CMOS Low Iq Voltage Regulator in an SC70-5

The NCP612/NCV612 series of fixed output linear regulators are designed for handheld communication equipment and portable battery powered applications which require low quiescent. The NCP612/NCV612 series features an ultra-low quiescent current of 40 μ A. Each device contains a voltage reference unit, an error amplifier, a PMOS power transistor, resistors for setting output voltage, current limit, and temperature limit protection circuits.

The NCP612/NCV612 has been designed to be used with low cost ceramic capacitors. The device is housed in the micro-miniature SC70-5 surface mount package. Standard voltage versions are 1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.3, and 5.0 V.

Features

- Low Quiescent Current of 40 µA Typical
- Low Dropout Voltage of 300 mV at 100 mA
- Low Output Voltage Option
- Output Voltage Accuracy of 2.0%
- Temperature Range of -40°C to 85°C (NCP612) Temperature Range of -40°C to 125°C (NCV612)
- NCV Prefix for Automotive and Other Applications Requiring Site and Control Changes
- Pb–Free Packages are Available

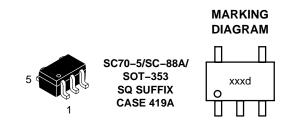
Typical Applications

- Cellular Phones
- Battery Powered Consumer Products
- Hand–Held Instruments
- Camcorders and Cameras



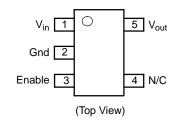
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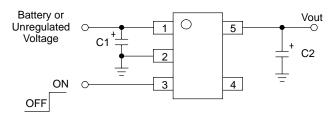
xxx = Specific Device Code d = Date Code

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.



This device contains 86 active transistors



PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description		
1	Vin	Positive power supply input voltage.		
2	Gnd	Power supply ground.		
3	Enable	This input is used to place the device into low-power standby. When this input is pulled low, the device is disabled. If this function is not used, Enable should be connected to Vin.		
4	N/C	No internal connection.		
5	Vout	Regulated output voltage.		

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	V _{in}	0 to 6.0	V
Enable Voltage	Enable	–0.3 to V _{in} +0.3	V
Output Voltage	V _{out}	–0.3 to V _{in} +0.3	V
Power Dissipation and Thermal Characteristics Power Dissipation Thermal Resistance, Junction-to-Ambient	Ρ _D R _{θJA}	Internally Limited 300	W °C/W
Operating Junction Temperature	TJ	+150	°C
Operating Ambient Temperature	T _A	-40 to +125	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.
1. This device series contains ESD protection and exceeds the following tests: Human Body Model 2000 V per MIL-STD-883, Method 3015 Machine Model Method 200 V
2. Latch-up capability (85°C) ± 200 mA DC with trigger voltage.

ELECTRICAL CHARACTERISTICS

 $(V_{in} = V_{out(nom.)} + 1.0 \text{ V}, V_{enable} = V_{in}, C_{in} = 1.0 \text{ }\mu\text{F}, C_{out} = 1.0 \text{ }\mu\text{F}, T_J = 25^{\circ}\text{C}, \text{ unless otherwise noted.})$

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage ($T_A = 25^{\circ}C$, $I_{out} = 10 \text{ mA}$)	Vout				V
1.5 V		1.455	1.5	1.545	
1.8 V		1.746	1.8	1.854	
2.5 V		2.425	2.5	2.575	
2.7 V		2.646	2.7	2.754	
2.8 V		2.744	2.8	2.856	
3.0 V		2.940	3.0	3.060	
3.1 V		3.038	3.1	3.162	
3.3 V		3.234	3.3	3.366	
5.0 V		4.900	5.0	5.100	
Output Voltage ($T_A = -40^{\circ}C$ to $85^{\circ}C$, $I_{out} = 10$ mA)	Vout				V
1.5 V		1.455	1.5	1.545	
1.8 V		1.746	1.8	1.854	
2.5 V		2.425	2.5	2.575	
2.7 V		2.619	2.7	2.781	
2.8 V		2.716	2.8	2.884	
3.0 V		2.910	3.0	3.090	
3.1 V		3.007	3.1	3.193	
3.3 V		3.201	3.3	3.399	
5.0 V		4.900	5.0	5.100	
Output Voltage ($T_A = -40^{\circ}$ C to 125°C, $I_{out} = 10$ mA) NCV612 Only	V _{out}				V
1.5 V	out	1.440	1.5	1.560	
1.8 V		1.728	1.8	1.872	
2.5 V		2.400	2.5	2.600	
2.7 V		2.592	2.7	2.808	
2.8 V		2.688	2.8	2.912	
3.0 V		2.880	3.0	3.120	
3.1 V		2.976	3.1	3.224	
3.3 V		3.201	3.3	3.399	
5.0 V		4.850	5.0	5.150	
Output Voltage ($T_A = -40^{\circ}$ C to 85°C, $I_{out} = 100$ mA)	V _{out}		0.0	0.100	V
1.5 V	v out	1.440	1.5	1.560	v
1.8 V					
		1.728	1.8	1.872	
2.5 V		2.400	2.5	2.600	
2.7 V		2.592	2.7	2.808	
2.8 V		2.688	2.8	2.912	
3.0 V		2.880	3.0	3.120	
3.1 V		2.976	3.1	3.224	
3.3 V		3.201	3.3	3.399	
5.0 V		4.850	5.0	5.150	
Line Regulation (I _{out} = 10 mA)	Reg _{line}				mV/V
1.5 V–4.4 V (V _{in} = V _{out(nom.)} + 1.0 V to 6.0 V)		-	1.0	3.0	
4.5 V–5.0 V (V _{in} = 5.5 V to 6.0 V)		-	1.0	3.0	
Load Regulation (I _{out} = 1.0 mA to 100 mA)	Reg _{load}	_	0.3	0.8	mV/mA
Output Current (V _{out} = (V _{out} at I _{out} = 100 mA) –3%)	I _{o(nom.)}				mA
$1.5 \text{ V}-3.9 \text{ V} (\text{V}_{\text{in}} = \text{V}_{\text{out(nom.)}} + 2.0 \text{ V})$		100	200	-	
$4.0 \text{ V}-5.0 \text{ V} (\text{V}_{\text{in}} = 6.0 \text{ V})$		100	200	-	
Dropout Voltage ($T_A = -40^{\circ}C$ to 85°C, $I_{out} = 100$ mA,	V _{in} –V _{out}				mV
Measured at V _{out} –3.0%)					
1.5 V		-	530	680	
1.8 V		-	420	560	
2.5 V		-	270	380	
2.7 V		-	270	380	
2.8 V		-	250	380	
3.0 V	1	-	230	380	
0.0 V					1
		-	210	380	
3.1 V 3.3 V		-	210 200	380 380	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{in} = V_{out(nom.)} + 1.0 \text{ V}, V_{enable} = V_{in}, C_{in} = 1.0 \mu\text{F}, C_{out} = 1.0 \mu\text{F}, T_J = 25^{\circ}\text{C}, \text{ unless otherwise noted.})$

Characteristic	Symbol	Min	Тур	Max	Unit
Quiescent Current ($T_A = -40^{\circ}C$ to $85^{\circ}C$) (Enable Input = 0 V) (Enable Input = V _{in} , I _{out} = 1.0 mA to I _{o(nom.)})	Ι _Q	- -	0.1 40	1.0 90	μΑ
Output Short Circuit Current ($V_{out} = 0 V$) 1.5 V-3.9 V ($V_{in} = V_{out(nom.)} + 2.0 V$) 4.0 V-5.0 V ($V_{in} = 6.0 V$)	I _{out(max)}	150 150	300 300	600 600	mA
Output Voltage Noise (f = 100 Hz to 100 kHz) $I_{out} = 30$ mA, $C_{out} = 1 \ \mu F$	Vn	_	100	-	μVrms
Enable Input Threshold Voltage (Voltage Increasing, Output Turns On, Logic High) (Voltage Decreasing, Output Turns Off, Logic Low)	V _{th(en)}	0.95 -		_ 0.3	V
Output Voltage Temperature Coefficient	T _C	-	±100	-	ppm/°C

3. Maximum package power dissipation limits must be observed.

$$PD = \frac{T_{J(max)} - T_{A}}{R_{A JA}}$$

4. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

TYPICAL CHARACTERISTICS

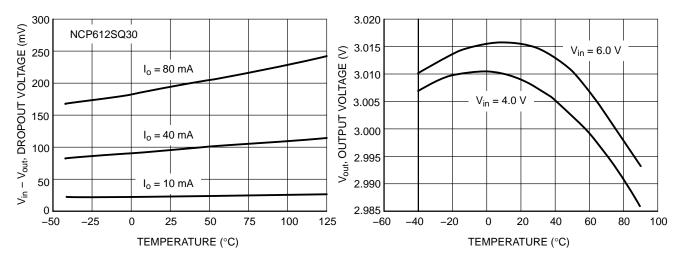


Figure 2. Dropout Voltage vs. Temperature



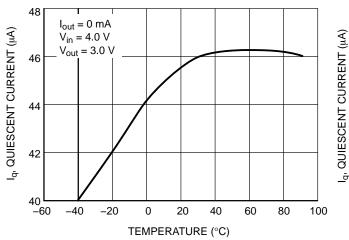


Figure 4. Quiescent Current vs. Temperature

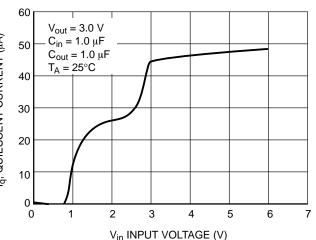
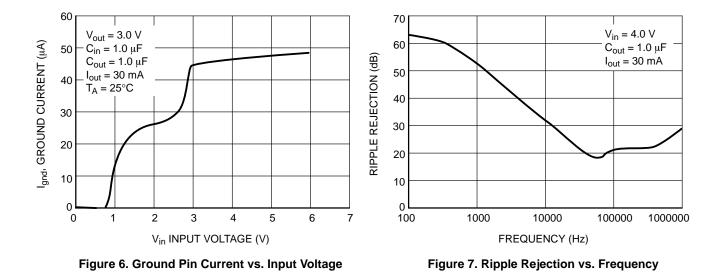
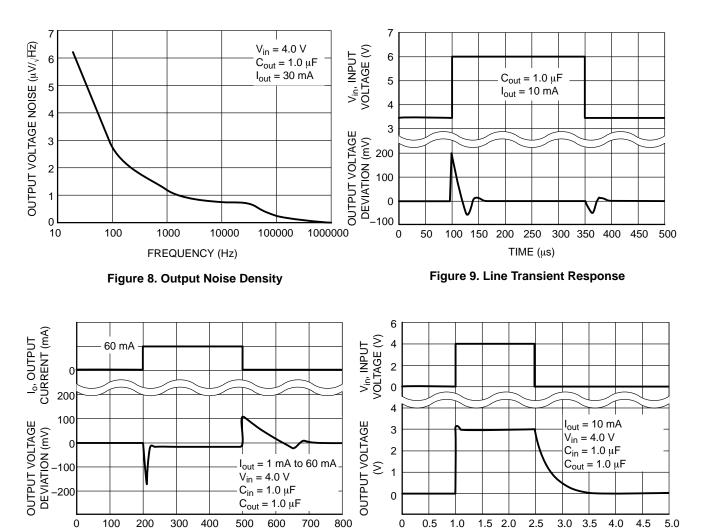


Figure 5. Quiescent Current vs. Input Voltage



TYPICAL CHARACTERISTICS



TIME (µs) Figure 10. Load Transient Response



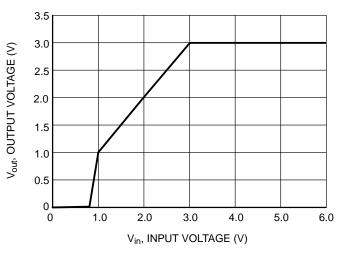


Figure 12. Output Voltage vs. Input Voltage

DEFINITIONS

Load Regulation

The change in output voltage for a change in output current at a constant temperature.

Dropout Voltage

The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 3.0% below its nominal. The junction temperature, load current, and minimum input supply requirements affect the dropout level.

Maximum Power Dissipation

The maximum total dissipation for which the regulator will operate within its specifications.

Quiescent Current

The quiescent current is the current which flows through the ground when the LDO operates without a load on its output: internal IC operation, bias, etc. When the LDO becomes loaded, this term is called the Ground current. It is actually the difference between the input current (measured through the LDO input pin) and the output current.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse technique such that the average chip temperature is not significantly affected.

Line Transient Response

Typical over and undershoot response when input voltage is excited with a given slope.

Thermal Protection

Internal thermal shutdown circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated at typically 160°C, the regulator turns off. This feature is provided to prevent failures from accidental overheating.

Maximum Package Power Dissipation

The maximum power package dissipation is the power dissipation level at which the junction temperature reaches its maximum operating value, i.e. 150°C. Depending on the ambient power dissipation and thus the maximum available output current.

APPLICATIONS INFORMATION

A typical application circuit for the NCP612/NCV612 is shown in Figure 1, front page.

Input Decoupling (C1)

A 1.0 μ F capacitor either ceramic or tantalum is recommended and should be connected close to the NCP612/NCV612 package. Higher values and lower ESR will improve the overall line transient response.

TDK capacitor: C2012X5R1C105K, or C1608X5R1A105K

Output Decoupling (C2)

The NCP612/NCV612 is a stable regulator and does not require any specific Equivalent Series Resistance (ESR) or a minimum output current. Capacitors exhibiting ESRs ranging from a few m Ω up to 5.0 Ω can thus safely be used. The minimum decoupling value is 1.0 μ F and can be augmented to fulfill stringent load transient requirements. The regulator accepts ceramic chip capacitors as well as tantalum capacitors. Larger values improve noise rejection and load regulation transient response.

TDK capacitor: C2012X5R1C105K, C1608X5R1A105K, or C3216X7R1C105K

Enable Operation

The enable pin will turn on the regulator when pulled high and turn off the regulator when pulled low. These limits of threshold are covered in the electrical specification section of this data sheet. If the enable is not used then the pin should be connected to V_{in} .

Hints

Please be sure the Vin and Gnd lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or cause the regulator to malfunction. Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

Thermal

As power across the NCP612/NCV612 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material and also the ambient temperature effect the rate of temperature rise for the part. This is stating that when the NCP612/NCV612 has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

The maximum dissipation the package can handle is given by:

$$PD = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}}$$

If junction temperature is not allowed above the maximum 125° C, then the NCP612/NCV612 can dissipate up to 330 mW @ 25° C.

The power dissipated by the NCP612/NCV612 can be calculated from the following equation:

$$P_{tot} = [V_{in} * I_{gnd} (I_{out})] + [V_{in} - V_{out}] * I_{out}$$

or

$$V_{inMAX} = \frac{P_{tot} + V_{out} * I_{out}}{I_{gnd} + I_{out}}$$

If an 100 mA output current is needed then the ground current from the data sheet is 40 μ A. For an NCP612/NCV612 (3.0 V), the maximum input voltage will then be 6.0 V (Limited by maximum input voltage).

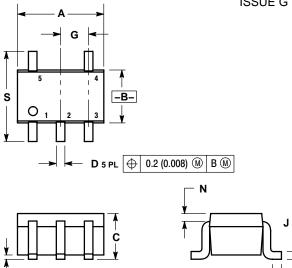
ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping [†]
NCP612SQ15T1	1.5	LHO		
NCP612SQ18T1	1.8	LHP		
NCP612SQ25T1	2.5	LHQ		
NCP612SQ27T1	2.7	LHR		
NCP612SQ28T1	2.8	LHS		
NCP612SQ30T1	3.0	LHT		
NCP612SQ31T1	3.1	LHU		
NCP612SQ33T1	3.3	LHV	SC70-5	3000 Units/
NCP612SQ50T1	5.0	LHW		
NCV612SQ15T1*	1.5	LHO	(SC-88A/SOT-353)	7″ Tape & Reel
NCV612SQ18T1*	1.8	LHP		
NCV612SQ25T1*	2.5	LHQ		
NCV612SQ27T1*	2.7	LHR		
NCV612SQ28T1*	2.8	LHS		
NCV612SQ30T1*	3.0	LHT		
NCV612SQ31T1*	3.1	LHU		
NCV612SQ33T1*	3.3	LHV		
NCV612SQ50T1*	5.0	LHW		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D. *NCV prefix for automotive and other applications requiring site and control changes.

PACKAGE DIMENSIONS

SC-88A/SOT-353/SC70-5 SQ SUFFIX CASE 419A-02 ISSUE G



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

2

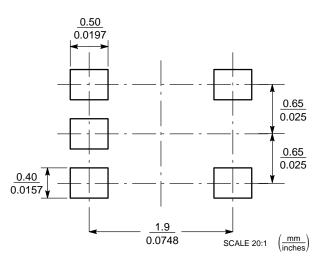
419A-01 OBSOLETE. NEW STANDARD 3. 419A-02

DIMENSIONS A AND B DO NOT INCLUDE 4 MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

SOLDERING FOOTPRINT*

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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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